



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Technology Center 2600

In re Application of:

Warren M. Farnworth et al.

Serial No.: 09/589,841

Filed: June 8, 2000

For: STEREOLITHOGRAPHIC METHODS
FOR FORMING A PROTECTIVE LAYER
ON A SEMICONDUCTOR DEVICE
SUBSTRATE AND SUBSTRATES
INCLUDING PROTECTIVE LAYERS SO
FORMED

Examiner: Unknown

Group Art Unit: 2776

Attorney Docket No.: 3923US (99-0033)

CERTIFICATE OF MAILING

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PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination of the above-referenced patent application on the merits, entry of the substitute specification (Appendix A) submitted herewith in clean form is respectfully requested. A marked-up substitute specification (Appendix B) is also being submitted herewith to clearly identify the amendments to the specification and claims, as required by Rule 121 (as amended). The substitute specification does not add new matter.

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